

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KYUJEONG SONG	06/17/2014
SEUNG HYUN JUNG	06/17/2014
MOON HEE CHOI	06/17/2014
IN SEOK JEONG	06/17/2014
JUNHEE HAN	06/17/2014
GEUN SIG CHA	06/17/2014
HAKHYUN NAM	06/17/2014
RECEIVING PARTY DATA	
Name:	I-SENS, INC.
Street Address:	27-34, GWANGUN-RO, NOWON-GU
City:	SEOUL
State/Country:	REPUBLIC OF KOREA
Postal Code:	139-845
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14371339
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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NAME OF SUBMITTER:	DOUGLAS W. SWARTZ
SIGNATURE:	/Douglas W. Swartz/
DATE SIGNED:	07/09/2014

PATENT

Total Attachments: 2

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Worldwide Assignment

WHEREAS, I/We **SONG, Kyujeong, JUNG, Seung Hyun, CHOI, Moon Hee, JEONG, In Seok, HAN, Junhee, CHA, Geun Sig and NAM, Hakhyun** have made an invention entitled **Cartridge for sensing elements in a sample** or which I/We have prepared an application for Letters Patent of the United States, or filed an application for Letters Patent of the United States on **July 9, 2014**, under Application No. **14/371,339**; and

WHEREAS, **I-sens, Inc.** ("ASSIGNEE"), a government agency duly registered in the State/Country of REPUBLIC OF KOREA, whose address is 27-34, Gwangun-ro, Nowon-gu, Seoul 139-845, Republic of Korea, desires to acquire the entire right, title, and interest in and to the invention, the application, and any Letters Patent to be granted for the invention in the United States and in all foreign countries;


NOW, THEREFORE, in view of good and valuable consideration, paid to me/us by ASSIGNEE(S), the receipt and sufficiency of which I/We acknowledge, I/We, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto ASSIGNEE(S), its successors, legal representatives, and assigns, the entire right, title, and interest in and to the invention, the application, all applications claiming benefit of the application, including, but not limited to, all divisions and continuation of the application, and all Letters Patent that may be granted thereon in the United States, and in all foreign countries, and all reissues thereof, together with the right to claim priority under the International Convention in all member countries; and I/We authorize and request the Director of Patents and Trademarks to issue all Letters Patent for the invention to ASSIGNEE(S), its successors, legal representatives, and assigns in accordance with the terms of this Assignment;


AND I/We covenant and agree that I/We have the full right to convey the entire right, title, and interest herein assigned and that I/We have not executed and will not execute any assignment or other instrument in conflict with this Assignment;


AND I/We further covenant and agree that upon request by ASSIGNEE(S), its successors, legal representatives, and/or assigns, and without further consideration, I/We will do all lawful acts that may be necessary or desirable to assist ASSIGNEE(S), its successors, legal representatives, and/or assigns to obtain and enforce patent protection for the invention in the United States and in all foreign countries, including, but not limited to, communicate with ASSIGNEE(S), its successors, legal representatives, and/or assigns any facts known to me/us regarding the invention, testify in any legal proceeding, sign all lawful papers, execute and deliver all papers that may be necessary or desirable to perfect the title to the invention in ASSIGNEE(S), its successors, legal representatives, and/or assigns, execute all divisional, continuation, and reissue applications, and make all rightful oaths, it being understood that any expense incident to the rendering of such assistance will be borne by ASSIGNEE(S), its successors, legal representatives, and/or assigns;


AND I/We further hereby authorize ASSIGNEE(S), or its attorneys or agents, to insert the correct Application Number and filing Date into this Assignment, if none is indicated on that date of my/our execution of this agreement.

IN WITNESS WHEREOF, I/We have executed this Assignment on the date(s) indicated below.

Signature: 
Date: June 17, 2014
Full Name: **SONG, Kyujeong**
Address: #101-804 Cheonggu Apt.
91, Seogyong-ro, Seongbuk-gu,
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Signature: 
Date: June 17, 2014
Full Name: **JUNG, Seung Hyun**
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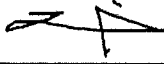
Signature: 
Date: June 17, 2014
Full Name: **CHOI, Moon Hee**
Address: #102-1203 Lotte Apt.

Signature: 
Date: June 17, 2014
Full Name: **JEONG, In Seok**
Address: 93-8, Dobong-ro 96-gil, Gangbuk-gu,

84, Dongho-ro, Seongdong-gu, Seoul
133-704, Republic of Korea

Seoul 142-865, Republic of Korea

Signature:



Date:

June 17, 2014

Full Name:

HAN, Junhee

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3F, 34, Nonhyeon-ro 155-gil,
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Signature:



Date:

June 17, 2014

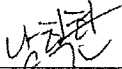
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CHA, Geun Sig

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Signature:



Date:

June 17, 2014

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NAM, Hakhyun

Address:

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69, Hancheon-ro 109-gil, Gangbuk-
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Signature:

Date:

Full Name:

Address: